

SN74AUP1T08 Low Power, 1.8, 2.5, 3.3-V Input, 3.3-V CMOS Output, Single 2-Input Positive-AND Gate

## 1 Features

- ESD Performance Tested Per JESD 22
  - 2000-V Human-Body Model (A114-B, Class II)
  - 1000-V Charged-Device Model (C101)
- Single-Supply Voltage Translator
- Output Level Up to Supply V<sub>CC</sub> CMOS Level
  - 1.8 V to 3.3 V (at V<sub>CC</sub> = 3.3 V)
  - 2.5 V to 3.3 V (at V<sub>CC</sub> = 3.3 V)
  - 1.8 V to 2.5 V (at V<sub>CC</sub> = 2.5 V)
  - 3.3 V to 2.5 V (at V<sub>CC</sub> = 2.5 V
- Schmitt-Trigger Inputs Reject Input Noise and Provide Better Output Signal Integrity
- I<sub>off</sub> Supports Partial Power Down (V<sub>CC</sub> = 0 V)
- Very Low Static Power Consumption: 0.1 µA
- Very Low Dynamic Power Consumption: 0.9 µA
- Latch-Up Performance Exceeds 100 mA Per JESD 78, Class II
- Pb-Free Packages Available: SC70 (DCK) 2 x 2.1 x 0.65 mm (Height 1.1 mm)
- More Gate Options Available at www.ti.com/ littlelogic

## **2** Description

The SN74AUP1T08 performs the Boolean function  $Y = A \cdot B \text{ or } Y = \overline{A + B}$  with designation for logic-level translation applications with output referenced to supply V<sub>CC</sub>.

AUP technology is the industry's lowest-power logic technology designed for use in extending battery-life in operating. All input levels that accept 1.8-V LVCMOS signals, while operating from either a single 3.3-V or 2.5-V  $V_{CC}$  supply. This product also maintains excellent signal integrity (see Figure 5-1 and Figure 5-2).

The wide  $V_{CC}$  range of 2.3 V to 3.6 V allows the possibility of switching output level to connect to external controllers or processors.

Schmitt-trigger inputs ( $\Delta V_T = 210 \text{ mV}$  between positive and negative input transitions) offer improved noise immunity during switching transitions, which is especially useful on analog mixed-mode designs. Schmitt-trigger inputs reject input noise, ensure integrity of output signals, and allow for slow input signal transition.

 $I_{off}$  is a feature that allows for powered-down conditions (V<sub>CC</sub> = 0 V) and is important in portable and mobile applications. When V<sub>CC</sub> = 0 V, signals in the range from 0 V to 3.6 V can be applied to the inputs and outputs of the device. No damage occurs to the device under these conditions.

The SN74AUP1T08 is designed with optimized current-drive capability of 4 mA to reduce line reflections, overshoot, and undershoot caused by high-drive outputs.

#### **Device Information**

PART NUMBER	PACKAGE <sup>(1)</sup>	BODY SIZE (NOM)
SN74AUP1T08	SC70 (5)	2mm x 1.25mm

(1) For all available packages, see the orderable addendum at the end of the data sheet.



Logic Diagram (AND Gate)



# **Table of Contents**

1 Features 2 Description 3 Revision History	1
4 Pin Configuration and Functions	
5 Specifications	4
5.1 Absolute Maximum Ratings	4
5.2 Recommended Operating Conditions	4
5.3 Electrical Characteristics	4
5.4 Switching Characteristics	<mark>5</mark>
5.5 Switching Characteristics	<mark>6</mark>
5.6 Switching Characteristics	<mark>6</mark>
5.7 Switching Characteristics	6
5.8 Switching Characteristics	
5.9 Switching Characteristics	

5.10 Operating Char	acteristics	7
5.11 Typical Charact	eristics	7
<b>6</b> Parameter Measure	ment Information	8
7 Detailed Description	n	10
	Diagram	
	al Modes	
8 Device and Docume	entation Support	11
8.1 Documentation S	Support	11
8.2 Receiving Notific	ation of Documentation Updates.	11
8.3 Support Resource	es	11
8.4 Trademarks		11
8.5 Glossary		11
	ging, and Orderable Information	

# **3 Revision History**

NOTE: Page numbers for previous revisions may differ from page numbers in the current version.

Cł	nanges from Revision * (April 2010) to Revision A (September 2020)	Page
•	Added Device Information table, Device Functional Modes, Device and Documentation Support section	, and
	Mechanical, Packaging, and Orderable Information section	1
•	Updated the numbering format for tables, figures, and cross-references throughout the document	1



# **4** Pin Configuration and Functions

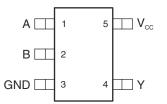


Figure 4-1. DCK Package 5-Pin SC70 Top View



## 5 Specifications 5.1 Absolute Maximum Ratings

over operating free-air temperature range (unless otherwise noted)<sup>(1)</sup>

			MIN	MAX	UNIT
V <sub>CC</sub>	Supply voltage range		-0.5	4.6	V
VI	Input voltage range <sup>(2)</sup>		-0.5	4.6	V
Vo	Voltage range applied to any output in the high-impedance or power-off	state <sup>(2)</sup>	-0.5	4.6	V
Vo	Output voltage range in the high or low state <sup>(2)</sup>		-0.5	V <sub>CC</sub> + 0.5	V
I <sub>IK</sub>	Input clamp current	V <sub>1</sub> < 0		-50	mA
I <sub>OK</sub>	Output clamp current	V <sub>O</sub> < 0		-50	mA
I <sub>O</sub>	Continuous output current			±20	mA
	Continuous current through $V_{CC}$ or GND			±50	mA
$\theta_{JA}$	Package thermal impedance <sup>(3)</sup>	DCK package		259	°C/W
T <sub>stg</sub>	Storage temperature		-65	150	°C

(1) Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

(2) The input negative-voltage and output voltage ratings may be exceeded if the input and output current ratings are observed.

(3) The package thermal impedance is calculated in accordance with JESD 51-7.

## 5.2 Recommended Operating Conditions

#### See<sup>(1)</sup>

			MIN	MAX	UNIT
V <sub>cc</sub>	Supply voltage		2.3	3.6	V
Vi	Input voltage		0	3.6	V
Vo	Output voltage		0	V <sub>CC</sub>	V
		V <sub>CC</sub> = 2.3 V		-3.1	mA
IOH	High-level output current	V <sub>CC</sub> = 3 V		$     \begin{array}{c}       3 & 3.6 \\       3.6 \\       V_{CC} \\       -3.1 \\       -4 \\       \overline{3.1} \\       4 \\       \end{array}       m $	IIIA
	Low-level output current	V <sub>CC</sub> = 2.3 V		3.1	mA
IOL	Low-level output current	V <sub>CC</sub> = 3 V		2.3 3.6 0 3.6 0 V <sub>CC</sub> -3.1 -4 3.1 4	IIIA
T <sub>A</sub>	Operating free-air temperature		-40	85	°C

 All unused inputs of the device must be held at V<sub>CC</sub> or GND to ensure proper device operation. See *Implications of Slow or Floating* CMOS Inputs, SCBA004.

### **5.3 Electrical Characteristics**

over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER	TEST CONDITIONS	V <sub>cc</sub>	T <sub>A</sub> =	: 25°C	T <sub>A</sub> = -40 to 85°C	UNIT	
			MIN	TYP MAX	to 85°C         MAX           0.6         1.1           0.75         1.19           0.35         0.6           0.5         0.85		
V <sub>T+</sub>		2.3 V to 2.7 V	0.6	1.1	0.6	1.1	
Positive-going input threshold voltage		3 V to 3.6 V	0.75	1.16	0.75	1.19	V
V <sub>T</sub>		2.3 V to 2.7 V	0.35	0.6	0.35	0.6	
Negative-going input threshold voltage		3 V to 3.6 V	0.5	0.85	0.5	0.85	V
ΔV <sub>T</sub>		2.3 V to 2.7 V	0.23	0.6	0.1	0.6	
Hysteresis (V <sub>T+</sub> – V <sub>T–</sub> )		3 V to 3.6 V	0.25	0.56	0.15	0.56	V
V <sub>OH</sub>	I <sub>OH</sub> = -20 μA	2.3 V to 3.6 V	$V_{CC} - 0.1$		V <sub>CC</sub> - 0.1		V
<sup>♥</sup> OH	I <sub>OH</sub> = -2.3 mA	2.3 V	2.05		1.97		v



### 5.3 Electrical Characteristics (continued)

over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER		TEST CONDITIONS	v <sub>cc</sub>	T <sub>A</sub> =	25°C		T <sub>A</sub> = -40 to 85°C		UNIT
				MIN	TYP	MAX	MIN	MAX	
		I <sub>OH</sub> = -3.1 mA		1.9			1.85		
		I <sub>OH</sub> = -2.7 mA	3 V	2.72			2.67		
		I <sub>OH</sub> = -4 mA	3 V	2.6			2.55		
		I <sub>OL</sub> = 20 μA	2.3 V to 3.6 V			0.1		0.1	
		I <sub>OL</sub> = 2.3 mA	2.3 V			0.31		0.33	
V <sub>OL</sub>	I <sub>OL</sub> = 3.1 mA	2.5 V			0.44		0.45	V	
	I <sub>OL</sub> = 2.7 mA	3 V			0.31		0.33		
		I <sub>OL</sub> = 4 mA	3 V			0.44		0.45	
I <sub>I</sub>	All inputs	V <sub>I</sub> = 3.6 V or GND	0 V to 3.6 V			0.1		0.5	μA
I <sub>off</sub>		$V_{I}$ or $V_{O}$ = 0 V to 3.6 V	0 V			0.1		0.5	μA
Δl <sub>off</sub>		$V_{\rm I}$ or $V_{\rm O}$ = 3.6 V	0 V to 0.2 V			0.2		0.5	μA
I <sub>CC</sub>		V <sub>I</sub> = 3.6 V or GND, I <sub>O</sub> = 0	2.3 V to 3.6 V			0.5		0.9	μA
		One input at 0.3 V or 1.1 V, Other inputs at 0 or $V_{CC}$ , $I_0 = 0$	2.3 V to 2.7 V					4	
ΔI <sub>CC</sub>		One input at 0.45 V or 1.2 V, Other inputs at 0 or $V_{CC}$ , $I_0 = 0$	3 V to 3.6 V					0.33 0.45 0.33 0.45 0.5 0.5 0.5 0.5 0.9	μA
Ci		V <sub>I</sub> = V <sub>CC</sub> or GND	3.3 V		1.5				pF
Co		V <sub>O</sub> = V <sub>CC</sub> or GND	3.3 V		3				pF

### **5.4 Switching Characteristics**

over recommended operating free-air temperature range,  $V_{CC}$  = 2.5 V ± 0.2 V,  $V_I$  = 1.8 V ± 0.15 V (unless otherwise noted) (see Figure 6-1)

	PARAMETER	FROM (INPUT)	TO (OUTPUT)	CL	٦	. = 25°C		T <sub>A</sub> = to 85		UNIT	
					MIN	TYP	MAX	MIN	MAX		
		A an D		5 pF	1.8	2.3	2.9	0.5	6.8		
				10 pF	2.3	2.8	3.4	1	7.9		
	чрd	A or B	ř	15 pF	2.6	3.1	3.8	1	8.7	ns	
				30 pF	3.8	4.4	5.1	1.5	10.8		



## 5.5 Switching Characteristics

over recommended operating free-air temperature range,  $V_{CC}$  = 2.5 V ± 0.2 V,  $V_I$  = 2.5 V ± 0.2 V (unless otherwise noted) (see Figure 6-1)

PARAMETER	FROM	FROM TO (INPUT) (OUTPUT)	CL	Τ <sub>4</sub>	⊆ 25°C		T <sub>A</sub> = -4 to 85	40°C °C	UNIT
		(001901)		MIN	TYP	MAX	MIN	MAX	
		A D	5 pF	1.8	2.3	3.1	0.5	6	
	A or B		10 pF	2.2	2.8	3.5	1	7.1	
<sup>L</sup> pd	AOLP	ř	15 pF	2.6	3.2	5.2	1	7.9	ns
			30 pF	3.7	4.4	5.2	1.5	10	

## **5.6 Switching Characteristics**

over recommended operating free-air temperature range,  $V_{CC}$  = 2.5 V ± 0.2 V,  $V_I$  = 3.3 V ± 0.3 V (unless otherwise noted) (see Figure 6-1)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	CL	TA	_= 25°C		T <sub>A</sub> = -4 to 85	40°C °C	UNIT
	(INFOT)			MIN	TYP	MAX	MIN	MAX	
	5 pF	2	2.7	3.5	0.5	5.5			
	t <sub>pd</sub> A or B Y	Y	10 pF	2.4	3.1	3.9	1	6.5	
t <sub>pd</sub>			15 pF	2.8	3.5	4.3	1	7.4	ns
		30 pF	4	4.7	5.5	1.5	9.5		

## **5.7 Switching Characteristics**

over recommended operating free-air temperature range,  $V_{CC}$  = 3.3 V ± 0.3 V,  $V_I$  = 1.8 V ± 0.15 V (unless otherwise noted) (see Figure 6-1)

PARAMETER	FROM	TO (OUTPUT)	CL	مT	⊆ 25°C		T <sub>A</sub> = -4 to 85	UNIT	
	(INPUT)		-	MIN	TYP	MAX	MIN	MAX	
	5 pF	1.6	2	2.5	0.5	8			
+	t <sub>pd</sub> A or B	Y	10 pF	2	2.4	2.9	1	8.5	20
Lpd			15 pF	2.3	2.8	3.3	1	9.1	ns
			30 pF	3.4	3.9	4.4	1.5	9.8	

## **5.8 Switching Characteristics**

over recommended operating free-air temperature range,  $V_{CC}$  = 3.3 V ± 0.3 V,  $V_I$  = 2.5 V ± 0.2 V (unless otherwise noted) (see Figure 6-1)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	CL	٦	⊆ 25°C		T <sub>A</sub> = -4 to 85	40°C °C	UNIT		
		(001201)		MIN	TYP	MAX	MIN	MAX			
t <sub>pd</sub> A or B		Y	Y	5 pF	1.6	1.9	2.4	0.5	5.3		
	A or P			Y	10 pF	2	2.3	2.7	1	6.1	
	AUB				ř	T	15 pF	2.3	2.7	3.1	1
			30 pF	3.4	3.8	4.2	1.5	8.5			



## **5.9 Switching Characteristics**

over recommended operating free-air temperature range,  $V_{CC}$  = 3.3 V ± 0.3 V,  $V_{I}$  = 3.3 V ± 0.3 V (unless otherwise noted) (see Figure 6-1)

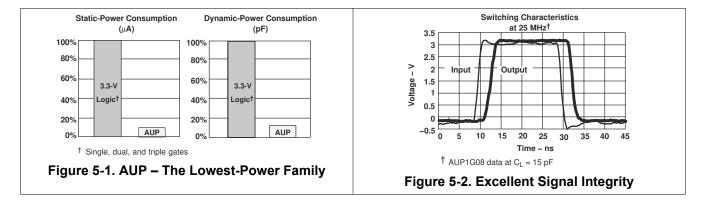
PARAMETER	FROM	TO (OUTPUT)	CL	٦	= 25°C		T <sub>A</sub> = -4 to 85	40°C °C	UNIT			
	(INPUT)	(001201)	-	MIN	TYP	MAX	MIN	MAX				
t <sub>pd</sub>	A or B	Y		5 pF	1.6	2.1	2.7	0.5	4.7			
			10 pF	2	2.4	3	1	5.7				
	AUB		ř	ř	T	15 pF	2.3	2.7	3.3	1	6.2	ns
			30 pF	3.4	3.8	4.4	1.5	7.8				

### **5.10 Operating Characteristics**

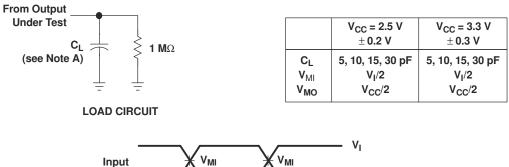
T<sub>A</sub> = 25°C

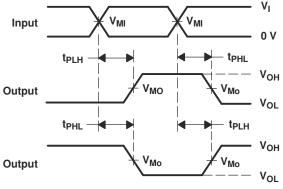
	PARAMETER	TEST CONDITIONS	V <sub>CC</sub> = 2.5 V	V <sub>CC</sub> = 3.3 V	UNIT
		TEST CONDITIONS	TYP TYP		UNIT
C	C <sub>pd</sub> Power dissipation capacitance	f = 10 MHz	4	5	pF

### **5.11 Typical Characteristics**



## **6** Parameter Measurement Information

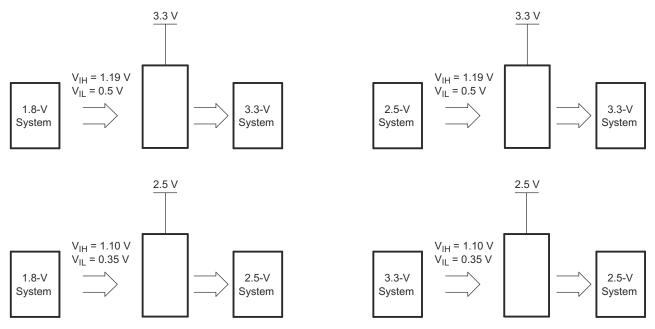




#### VOLTAGE WAVEFORMS PROPAGATION DELAY TIMES INVERTING AND NONINVERTING OUTPUTS

- NOTES: A. CL includes probe and jig capacitance.
  - B. All input pulses are supplied by generators having the following characteristics: PRR  $\leq$  10 MHz, Z<sub>O</sub> = 50  $\Omega$ , slew rate  $\geq$  1 V/ns.
  - C. The outputs are measured one at a time, with one transition per measurement.
  - D.  $t_{PLH}$  and  $t_{PHL}$  are the same as  $t_{pd}$ .









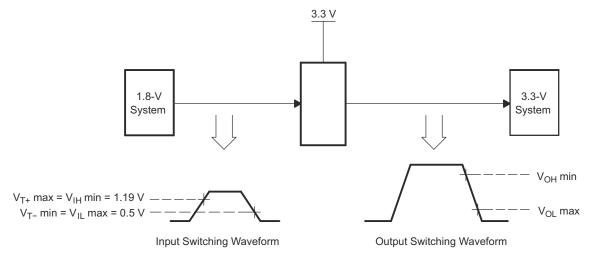


Figure 6-3. Switching Thresholds For 1.8-V To 3.3-V Translation



## 7 Detailed Description

## 7.1 Functional Block Diagram



Figure 7-1. Logic Diagram (AND Gate)

### 7.2 Device Functional Modes

Table 7-1 through Table 7-3 list the functional modes of the SN74AUP1T08 device.

Table 7-1. Function Table								
INP (Lower Le	OUTPUT (V <sub>CC</sub> CMOS)							
Α	В	Y						
Н	Н	Н						
L	Х	L						
Х	L	L						

## Table 7-1. Function Table

#### Table 7-2. Supply $V_{CC}$ = 2.3 V To 2.7 V (2.5 V)

INP V <sub>T+</sub> max V <sub>T-</sub> min =	OUTPUT CMOS
Α	Y
V <sub>IH</sub> =	V <sub>OH</sub> = 1.85 V
$V_{IL} = 0$	V <sub>OL</sub> = 0.45 V

Table 7-3. Supply  $V_{CC}$  = 3 V To 3.6 V (3.3 V)

INP V <sub>T+</sub> max = V <sub>T-</sub> min =	OUTPUT CMOS				
Α	A B				
V <sub>IH</sub> = ·	V <sub>OH</sub> = 2.55 V				
V <sub>IL</sub> =	V <sub>OL</sub> = 0.45 V				



## 8 Device and Documentation Support

### 8.1 Documentation Support

#### 8.1.1 Related Documentation

For related documentation see the following:

Implications of Slow or Floating CMOS Inputs, SCBA004

### 8.2 Receiving Notification of Documentation Updates

To receive notification of documentation updates, navigate to the device product folder on ti.com. Click on *Subscribe to updates* to register and receive a weekly digest of any product information that has changed. For change details, review the revision history included in any revised document.

#### 8.3 Support Resources

TI E2E<sup>™</sup> support forums are an engineer's go-to source for fast, verified answers and design help — straight from the experts. Search existing answers or ask your own question to get the quick design help you need.

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#### 8.4 Trademarks

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#### 8.5 Glossary

**TI Glossary** This glossary lists and explains terms, acronyms, and definitions.

### 9 Mechanical, Packaging, and Orderable Information

The following pages include mechanical, packaging, and orderable information. This information is the most current data available for the designated devices. This data is subject to change without notice and revision of this document. For browser-based versions of this data sheet, refer to the left-hand navigation.



### **PACKAGING INFORMATION**

Orderable part number	Status	Material type	Package   Pins	Package qty   Carrier	RoHS	Lead finish/	MSL rating/	Op temp (°C)	Part marking
	(1)	(2)			(3)	Ball material	Peak reflow		(6)
						(4)	(5)		
SN74AUP1T08DCKR	Active	Production	SC70 (DCK)   5	3000   LARGE T&R	Yes	NIPDAU   SN	Level-1-260C-UNLIM	-40 to 85	6EF
SN74AUP1T08DCKR.B	Active	Production	SC70 (DCK)   5	3000   LARGE T&R	Yes	SN	Level-1-260C-UNLIM	-40 to 85	6EF
SN74AUP1T08DCKRG4	Active	Production	SC70 (DCK)   5	3000   LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 85	6EF
SN74AUP1T08DCKRG4.B	Active	Production	SC70 (DCK)   5	3000   LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 85	6EF

<sup>(1)</sup> **Status:** For more details on status, see our product life cycle.

<sup>(2)</sup> Material type: When designated, preproduction parts are prototypes/experimental devices, and are not yet approved or released for full production. Testing and final process, including without limitation quality assurance, reliability performance testing, and/or process qualification, may not yet be complete, and this item is subject to further changes or possible discontinuation. If available for ordering, purchases will be subject to an additional waiver at checkout, and are intended for early internal evaluation purposes only. These items are sold without warranties of any kind.

<sup>(3)</sup> RoHS values: Yes, No, RoHS Exempt. See the TI RoHS Statement for additional information and value definition.

<sup>(4)</sup> Lead finish/Ball material: Parts may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

<sup>(5)</sup> MSL rating/Peak reflow: The moisture sensitivity level ratings and peak solder (reflow) temperatures. In the event that a part has multiple moisture sensitivity ratings, only the lowest level per JEDEC standards is shown. Refer to the shipping label for the actual reflow temperature that will be used to mount the part to the printed circuit board.

<sup>(6)</sup> Part marking: There may be an additional marking, which relates to the logo, the lot trace code information, or the environmental category of the part.

Multiple part markings will be inside parentheses. Only one part marking contained in parentheses and separated by a "~" will appear on a part. If a line is indented then it is a continuation of the previous line and the two combined represent the entire part marking for that device.

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Texas

STRUMENTS

## TAPE AND REEL INFORMATION





#### QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE



*All dimensions are nominal												
Device	•	Package Drawing		SPQ	Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
SN74AUP1T08DCKR	SC70	DCK	5	3000	180.0	8.4	2.3	2.5	1.2	4.0	8.0	Q3
SN74AUP1T08DCKRG4	SC70	DCK	5	3000	178.0	9.0	2.4	2.5	1.2	4.0	8.0	Q3



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# PACKAGE MATERIALS INFORMATION

5-Jul-2025



\*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
SN74AUP1T08DCKR	SC70	DCK	5	3000	210.0	185.0	35.0
SN74AUP1T08DCKRG4	SC70	DCK	5	3000	180.0	180.0	18.0

# **DCK0005A**



# **PACKAGE OUTLINE**

# SOT - 1.1 max height

SMALL OUTLINE TRANSISTOR



NOTES:

- 1. All linear dimensions are in millimeters. Any dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.
   This drawing is subject to change without notice.
   Reference JEDEC MO-203.

- 4. Support pin may differ or may not be present.5. Lead width does not comply with JEDEC.
- 6. Body dimensions do not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0.25mm per side



# **DCK0005A**

# **EXAMPLE BOARD LAYOUT**

# SOT - 1.1 max height

SMALL OUTLINE TRANSISTOR



NOTES: (continued)

Publication IPC-7351 may have alternate designs.
 Solder mask tolerances between and around signal pads can vary based on board fabrication site.



# DCK0005A

# **EXAMPLE STENCIL DESIGN**

# SOT - 1.1 max height

SMALL OUTLINE TRANSISTOR



NOTES: (continued)

9. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.

10. Board assembly site may have different recommendations for stencil design.



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